



End of Life Notification of Micron 512Mb/1Gb based LPDDR2 25nm Product (U97M/U98M)

PCN: 33495

Published: 2019-11-09

Type:	Die Shrink/Technology Transition, End of Life
Description:	Micron is announcing the EOL of Industrial Temperature 25nm LPDDR2 512Mb/1Gb based Parts (U97M/U98M)
Reason:	Manufacturing Efficiency

Product Affected: All 512Mb / 1Gb / 2Gb / 4Gb 25nm LPDDR2 Industrial Temperature Components (U97M/U98M)

Affected Micron Part Number	Recommended Replacement	Customer Part Number
EDB2432B4MA-1DIT-F-R DRAM	MT42L64M32D2HE-18 IT:D	
EDB1316BDBH-1DIT-F-D	Contact Sales Representative	
EDB1332BDBH-1DIT-F-D	MT42L32M32D1HE-18 IT:D	
EDB1332BDBH-1DIT-F-R	MT42L32M32D1HE-18 IT:D	
EDB2432B4MA-1DIT-F-D	MT42L64M32D2HE-18 IT:D	
EDB4064B4PB-1DIT-F-D	Contact Sales Representative	
EDB4064B4PB-1DIT-F-R	Contact Sales Representative	557-2023-ND
EDB5432BEBH-1DIT-F-D	MT42L16M32D1HE-18 ITE	

*Materials that have been ordered are in **bold**.

Method of Identification:	Marketing Part Number
Micron Sites Affected:	Fab15 - JP
Qualification Plan:	New Product will be qualified according to Micron's standard qualification procedures
Sample Available:	2020-03-31
Qual Data Available:	2020-05-31
Last Purchase Date*:	2020-09-30
Last Shipment Date:	2021-03-31

Early placement of orders is encouraged as an increase in demand for this product could potentially exceed Micron's ability to meet all requests. All products from a previously accepted order that have not shipped as of the last-time purchase date will be considered non-cancelable and non-returnable. Changes to confirmed request dates will also require written approval by Micron. Should additional supply be available after the last-time purchase date, Micron may accept orders for product and such orders placed will be considered non-cancelable and non-returnable.

NOTE: Per JEDEC Standard JESD46-C Section 3.2.3; lack of acknowledgment of this PCN within 30 days constitutes acceptance of change.

Attachments

There are no attachments on this PCN